

Advances in Epitaxial GaInP/GaAs/Si Triple Junction Solar Cells



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3) TU Ilmenau

IEEE PVSC-47 Virtual conference

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III-V on Si

Motivation

- Silicon solar cells
 - Limited to 29.4 % efficiency¹⁾
 - Low cost of manufacturing
- III-V multi-junction solar cells
 - Highest efficiencies (38.8 %)²⁾
 - Proven stability (space)
 - Substrates costly



<https://www.pv-tech.org/news/new-nrel-study-details-us-rooftop-solar-pv-potential-at-1118gw-plus>



<https://sci.esa.int/web/solar-orbiter/-/solar-orbiter-antenna-deployment>

III-V on Si

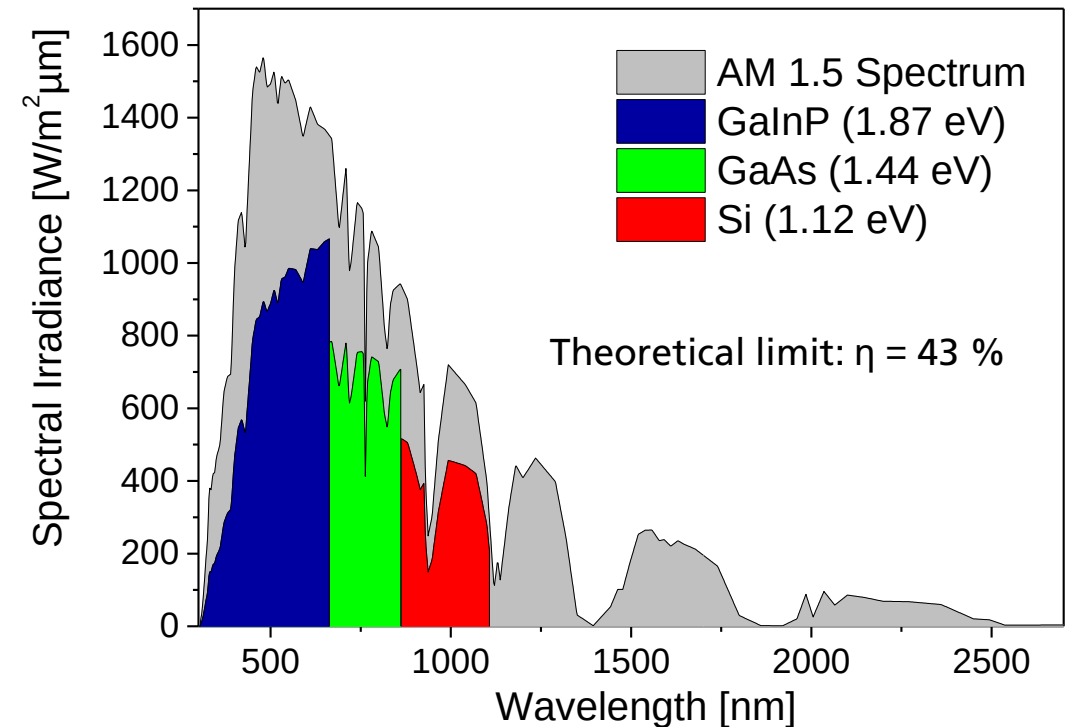
Motivation

■ Silicon solar cells

- Limited to 29.4 % efficiency¹⁾
- Low cost of manufacturing

■ III-V multi-junction solar cells

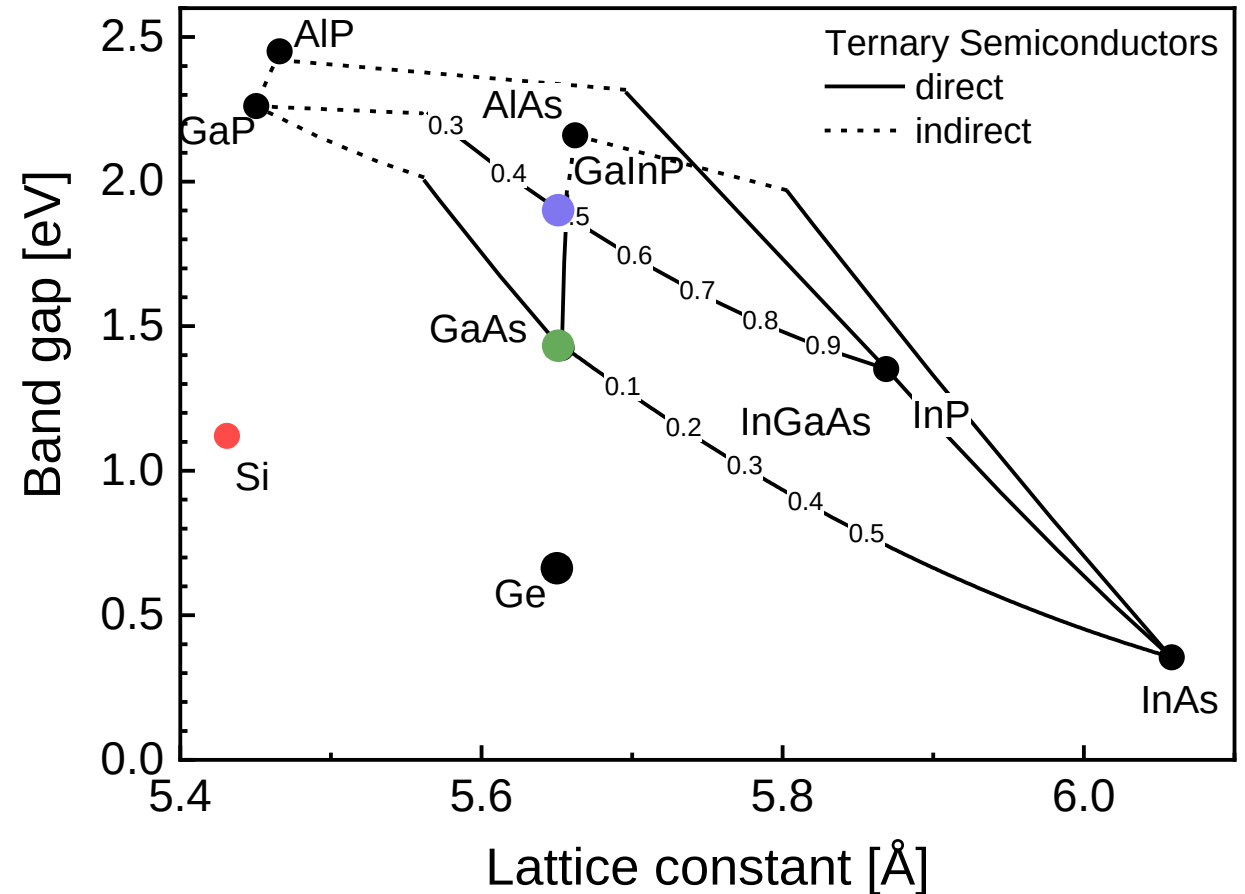
- Highest efficiencies (38.8 %)²⁾
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III-V on Si Challenges

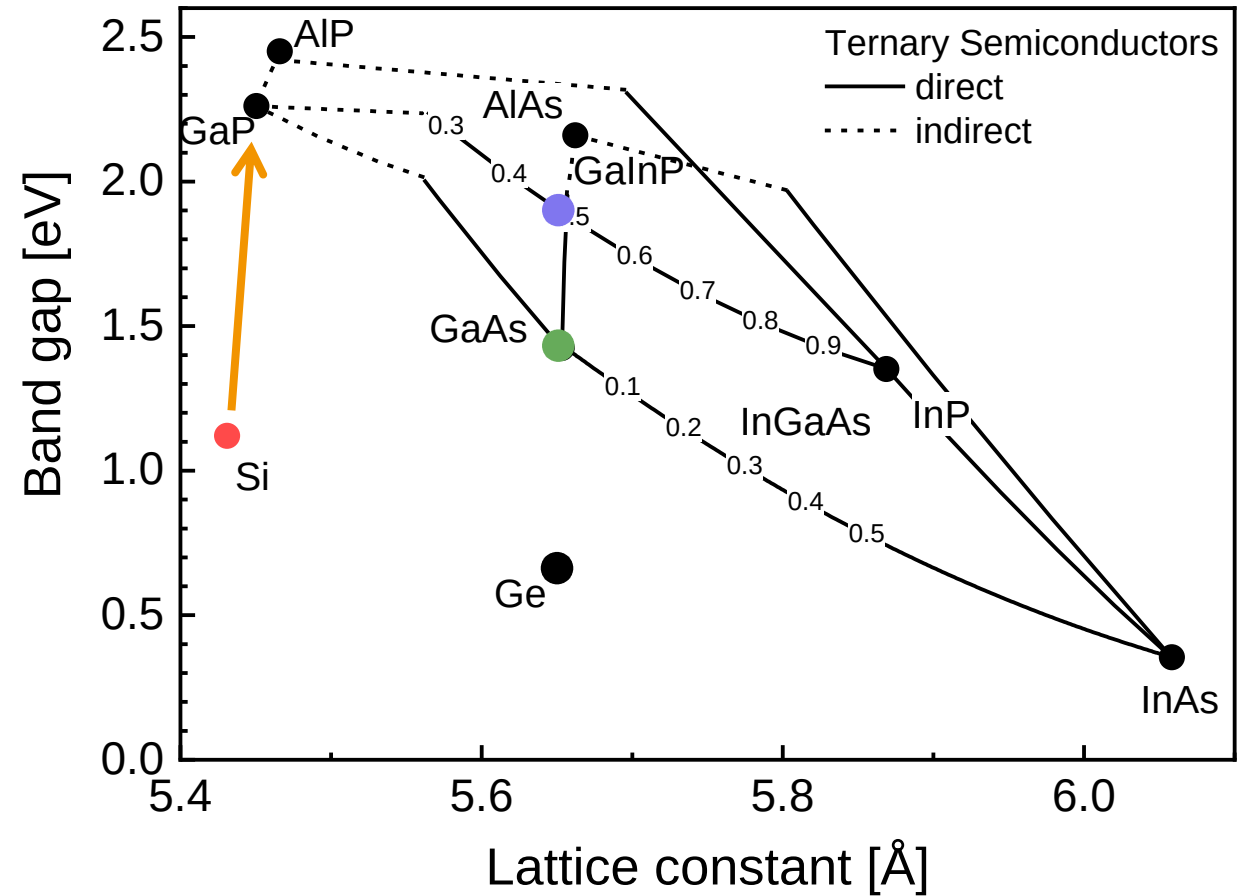
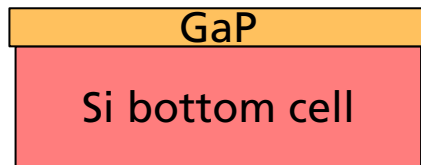
- III-V on Si
 - Polar (III-V) on non-polar (Si) crystals
 - Lattice mismatch of ~4%

→ III-V epitaxy on Si not trivial



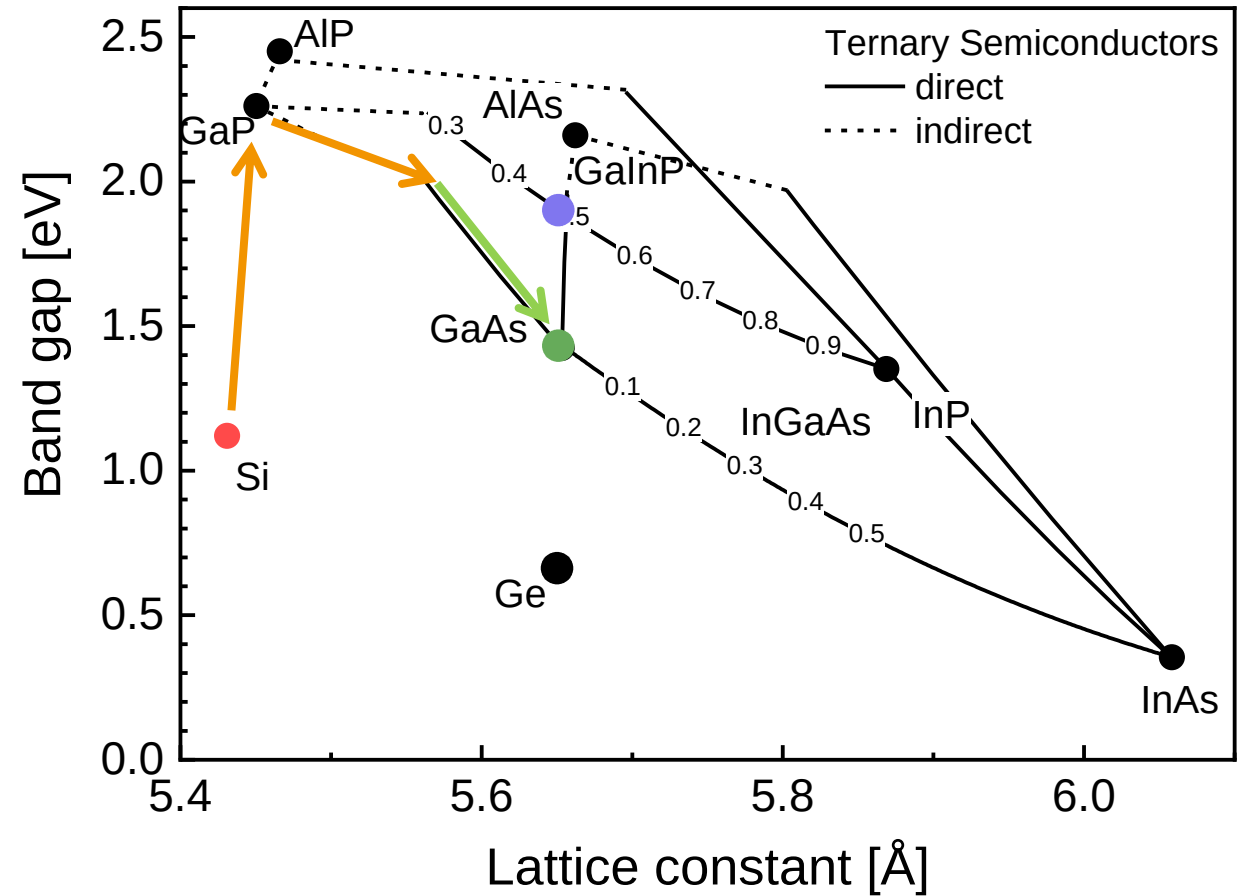
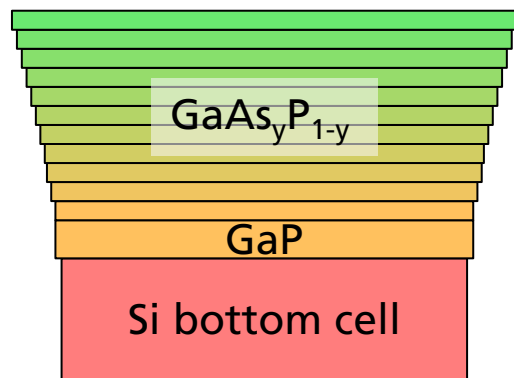
III-V on Si

MOVPE Approach



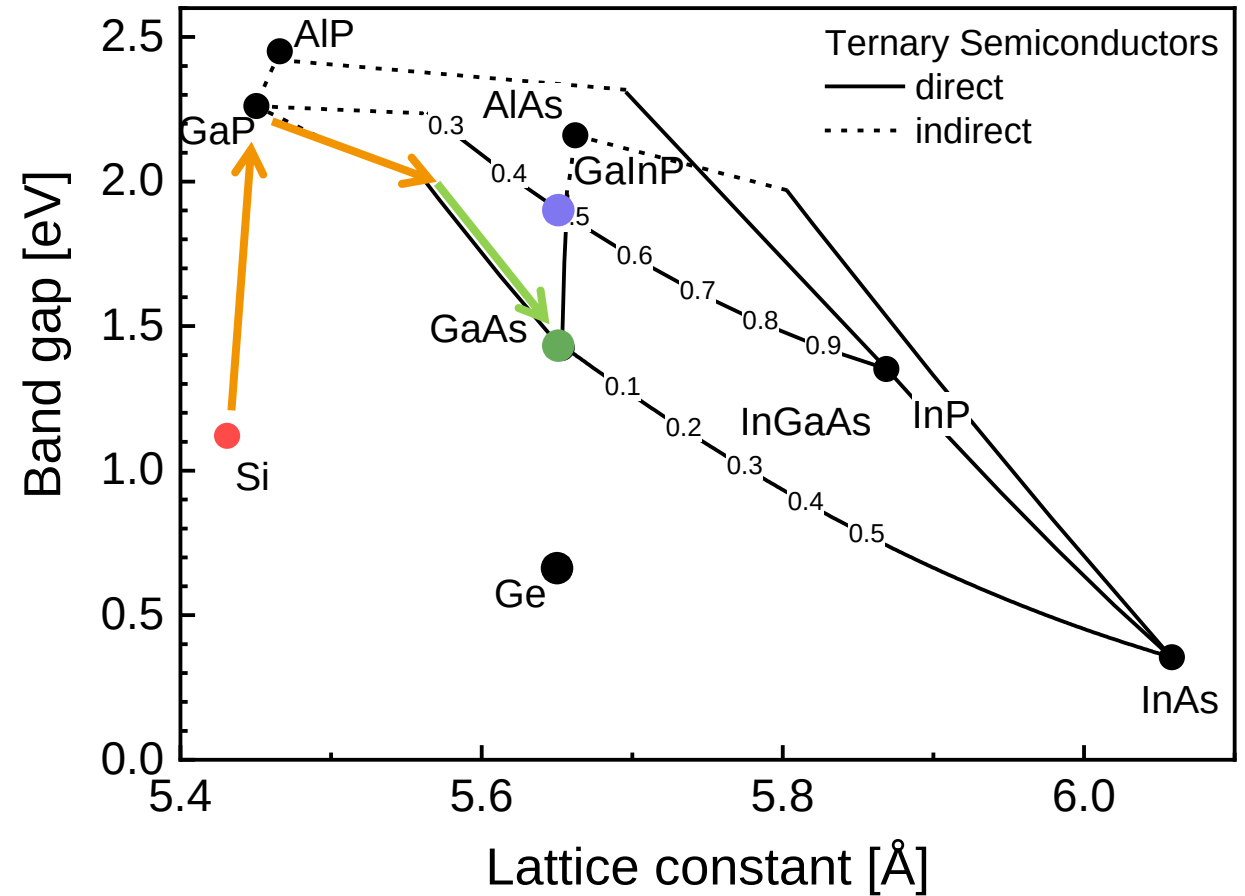
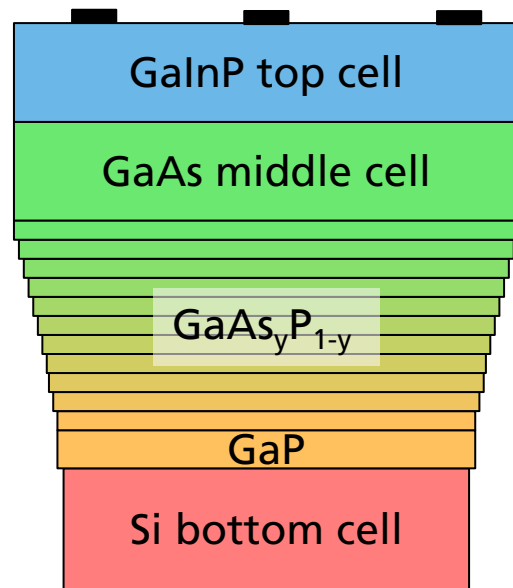
III-V on Si

MOVPE Approach



III-V on Si

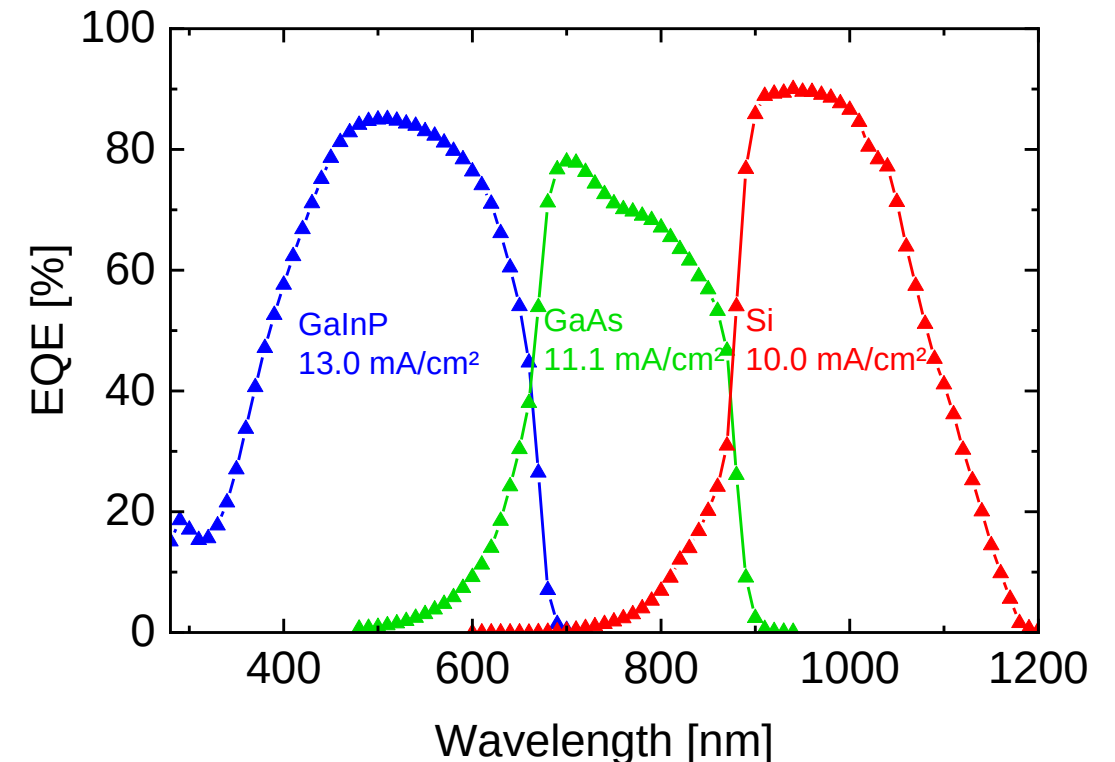
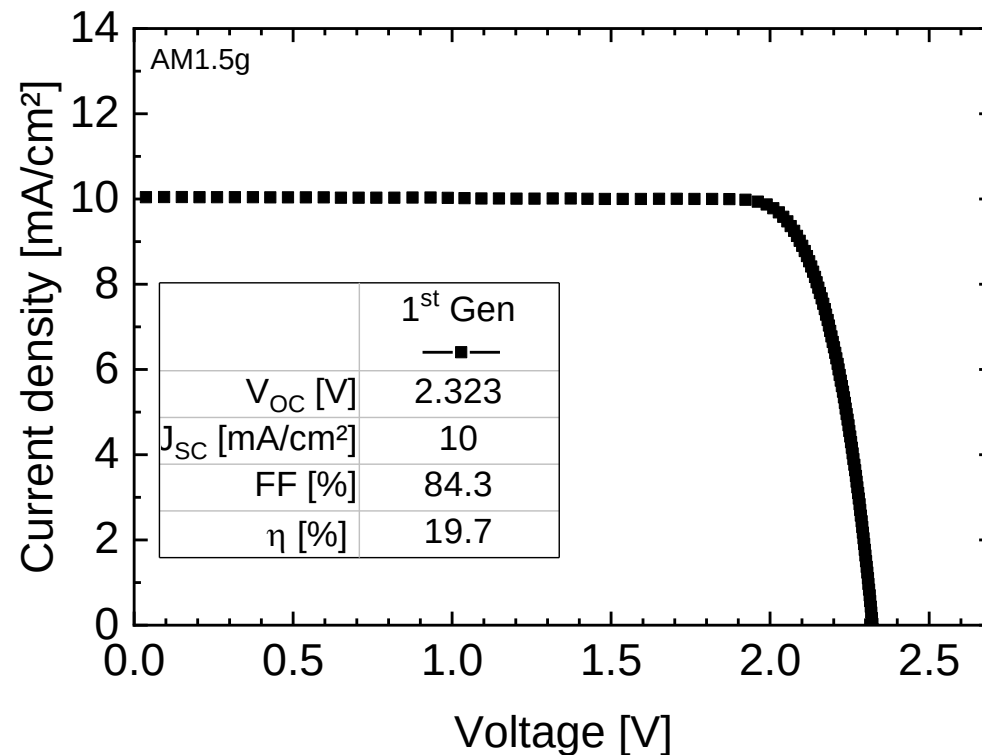
MOVPE Approach



1st Gen III-V on Si Solar Cell (2017)

Characterisation

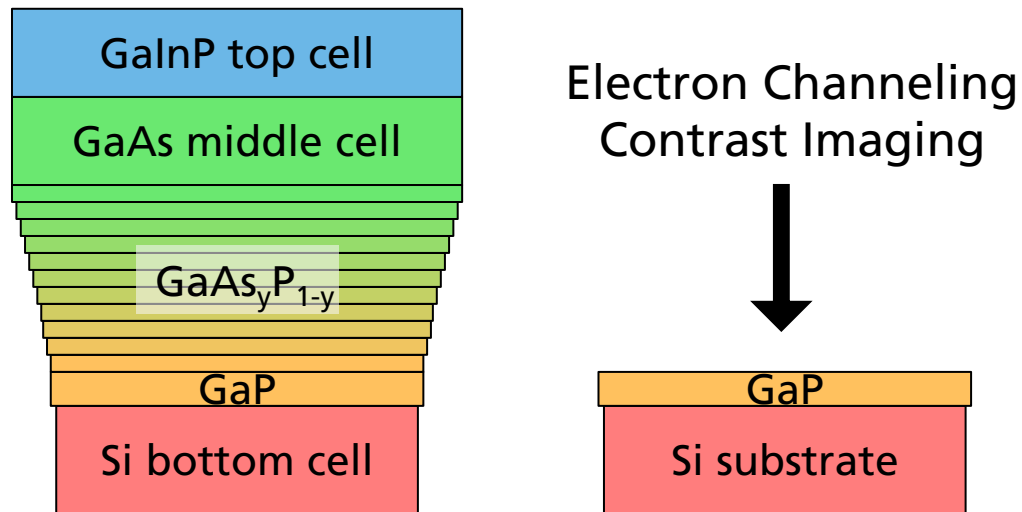
- Crystal defects limit voltage and quantum efficiency (TDD : $1.4 \times 10^8 \text{ cm}^{-2}$)



1st Gen III-V on Si Solar Cell

Defect Characterisation

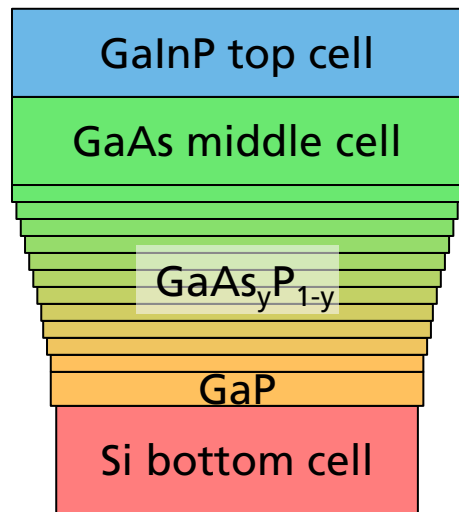
- Crystal defects limit voltage and quantum efficiency (TDD : $1.4 \times 10^8 \text{ cm}^{-2}$)
- GaP nucleation on Si
 - Stacking fault pyramids $6 \times 10^7 \text{ cm}^{-2}$



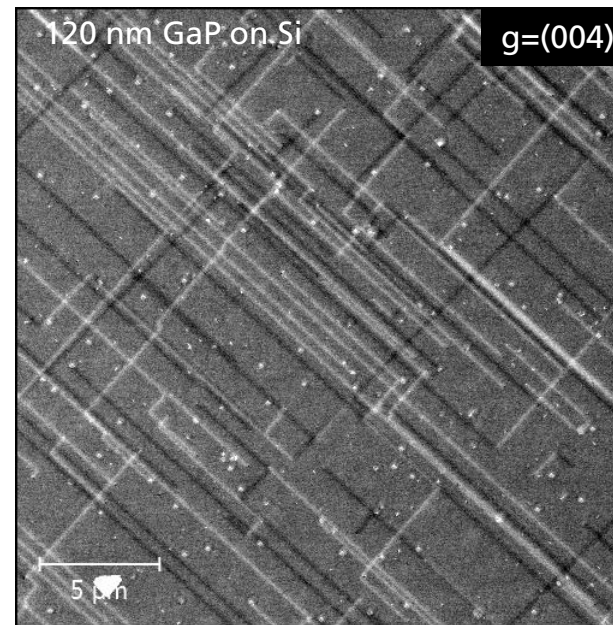
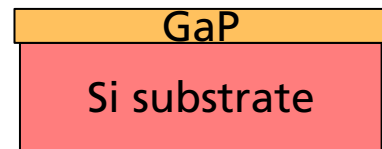
1st Gen III-V on Si Solar Cell

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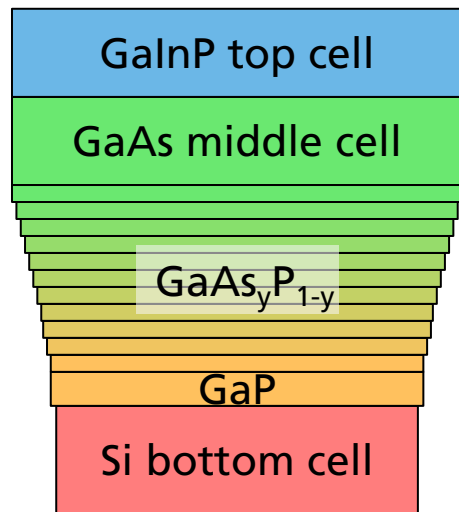
Electron Channeling
Contrast Imaging



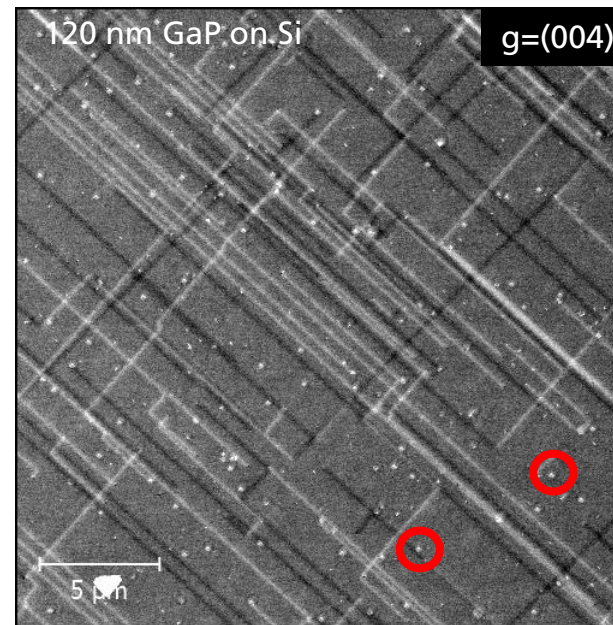
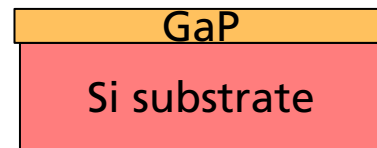
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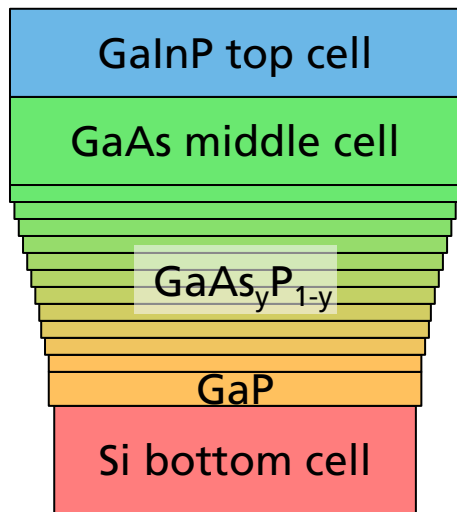
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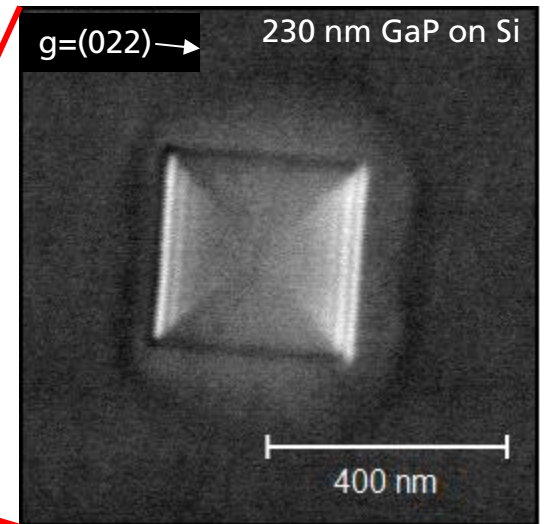
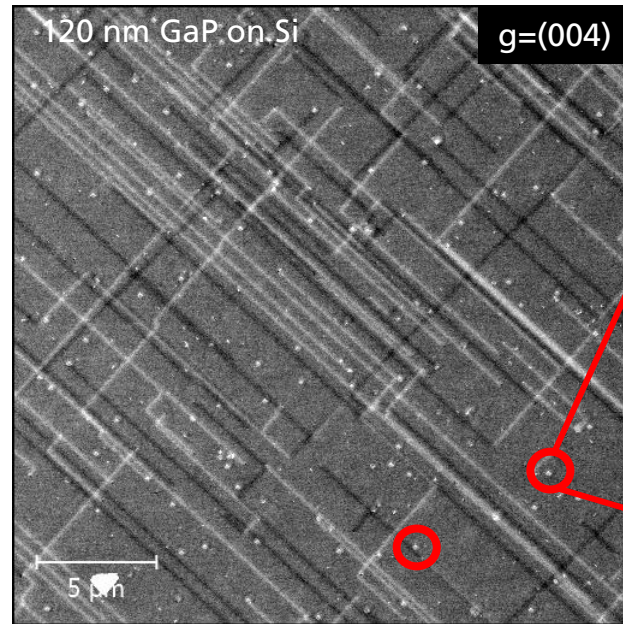
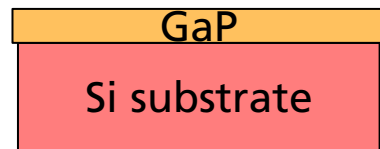
1st Gen III-V on Si Solar Cell

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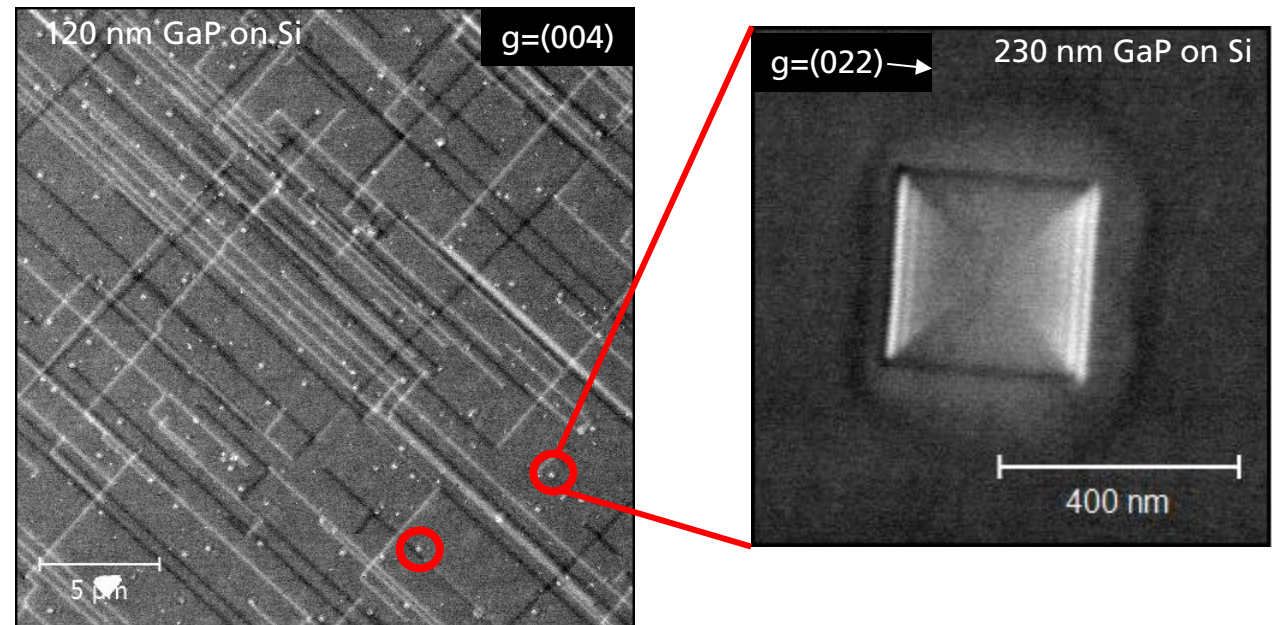
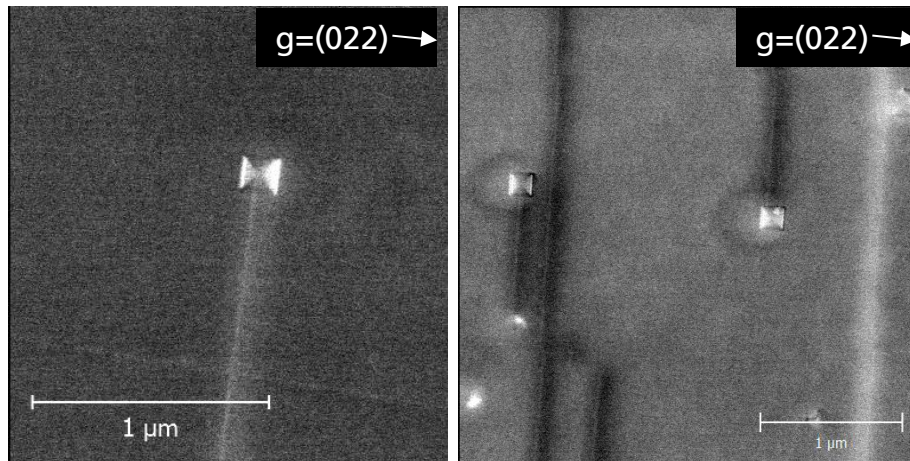
Electron Channeling
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1st Gen III-V on Si Solar Cell

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- Crystal defects limit voltage and quantum efficiency (TDD : $1.4 \times 10^8 \text{ cm}^{-2}$)
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 - Limited glide of dislocations

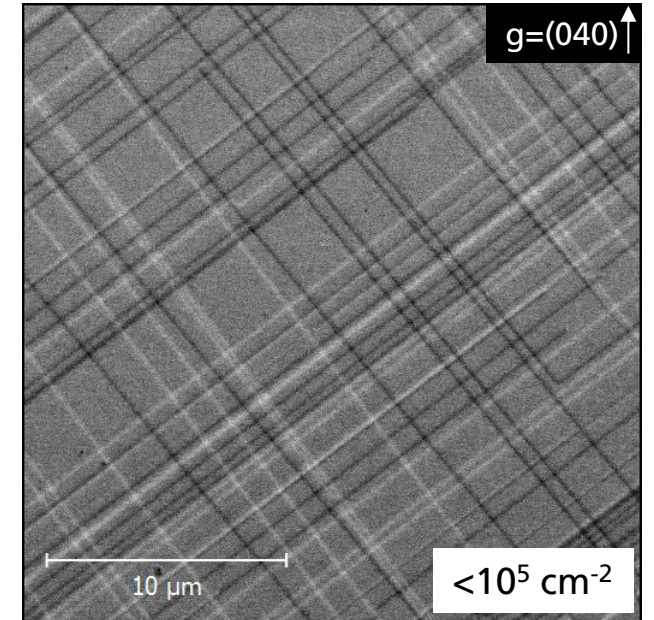
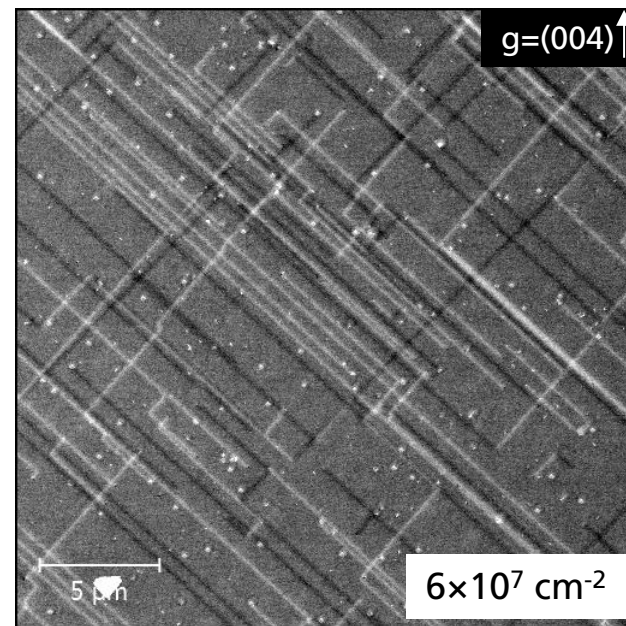


1st Gen III-V on Si Solar Cell

Reduction of Defect Density

- Crystal defects limit voltage and quantum efficiency (TDD : $1.4 \times 10^8 \text{ cm}^{-2}$)
- GaP nucleation on Si
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 - Limited glide of dislocations

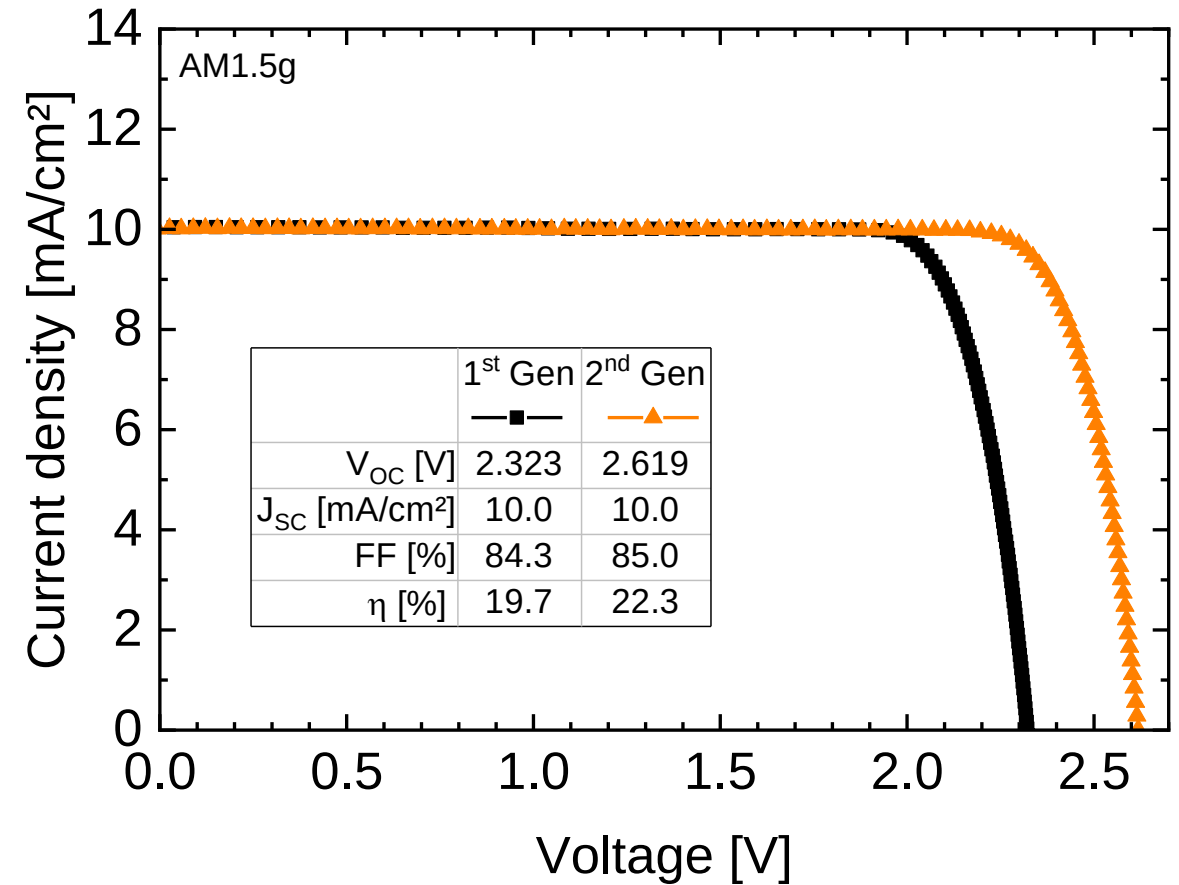
Optimization of GaP nucleation



2nd Gen III-V on Si Solar Cell (2019)

IV-Characteristics

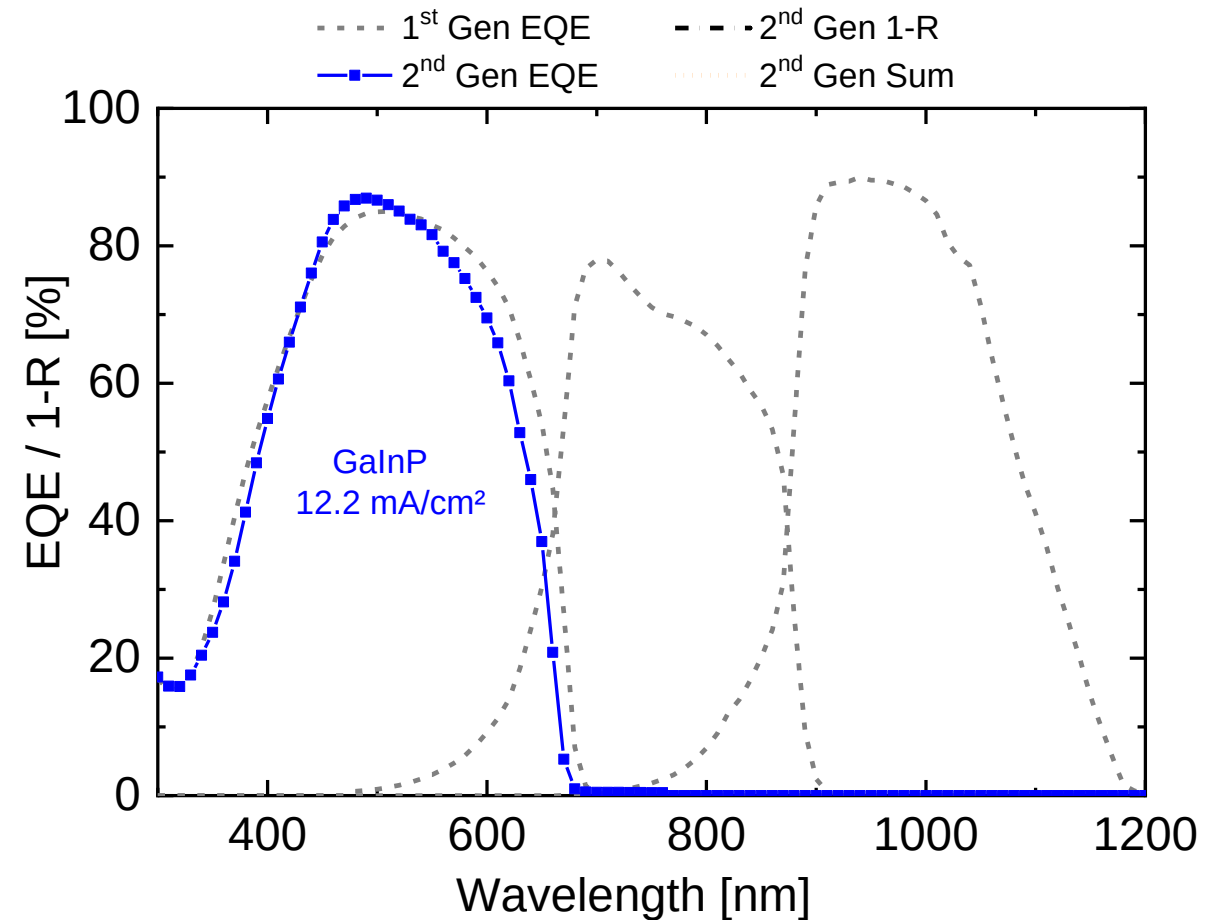
- IV:
 - Increase in V_{OC} by +296 mV
 - No change in J_{SC}



2nd Gen III-V on Si Solar Cell

EQE

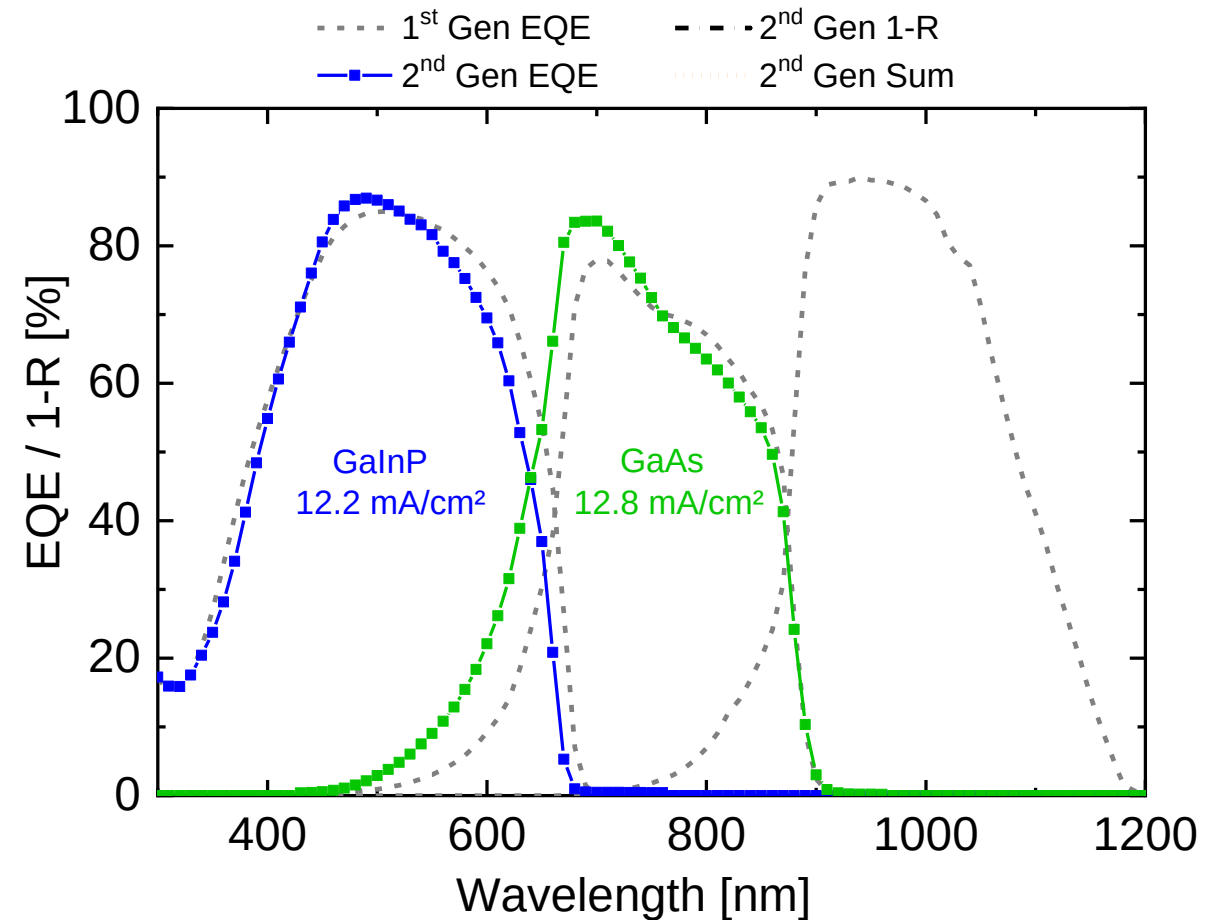
- IV:
 - Increase in V_{OC} by +296 mV
 - No change in J_{SC}
- EQE:
 - GaInP bandgap adjusted



2nd Gen III-V on Si Solar Cell

EQE

- IV:
 - Increase in V_{OC} by +296 mV
 - No change in J_{SC}
- EQE:
 - GaInP bandgap adjusted
 - Thinner GaAs cell (760 nm vs 1200 nm) with higher EQE



2nd Gen III-V on Si Solar Cell

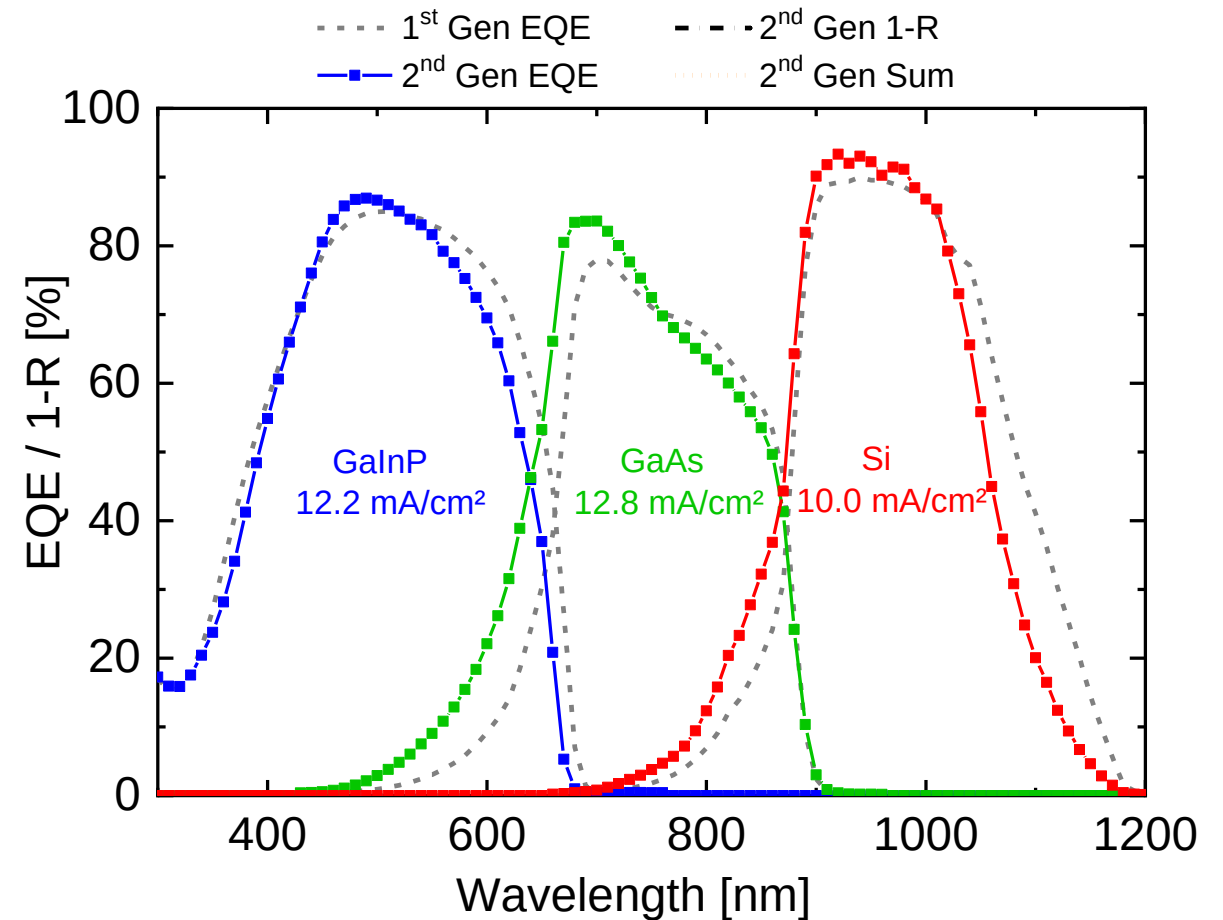
EQE

■ IV:

- Increase in V_{OC} by +296 mV
- No change in J_{SC}

■ EQE:

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- Thinner GaAs cell (760 nm vs 1200 nm) with higher EQE
- Poor light trapping in Si bottom cell



2nd Gen III-V on Si Solar Cell EQE

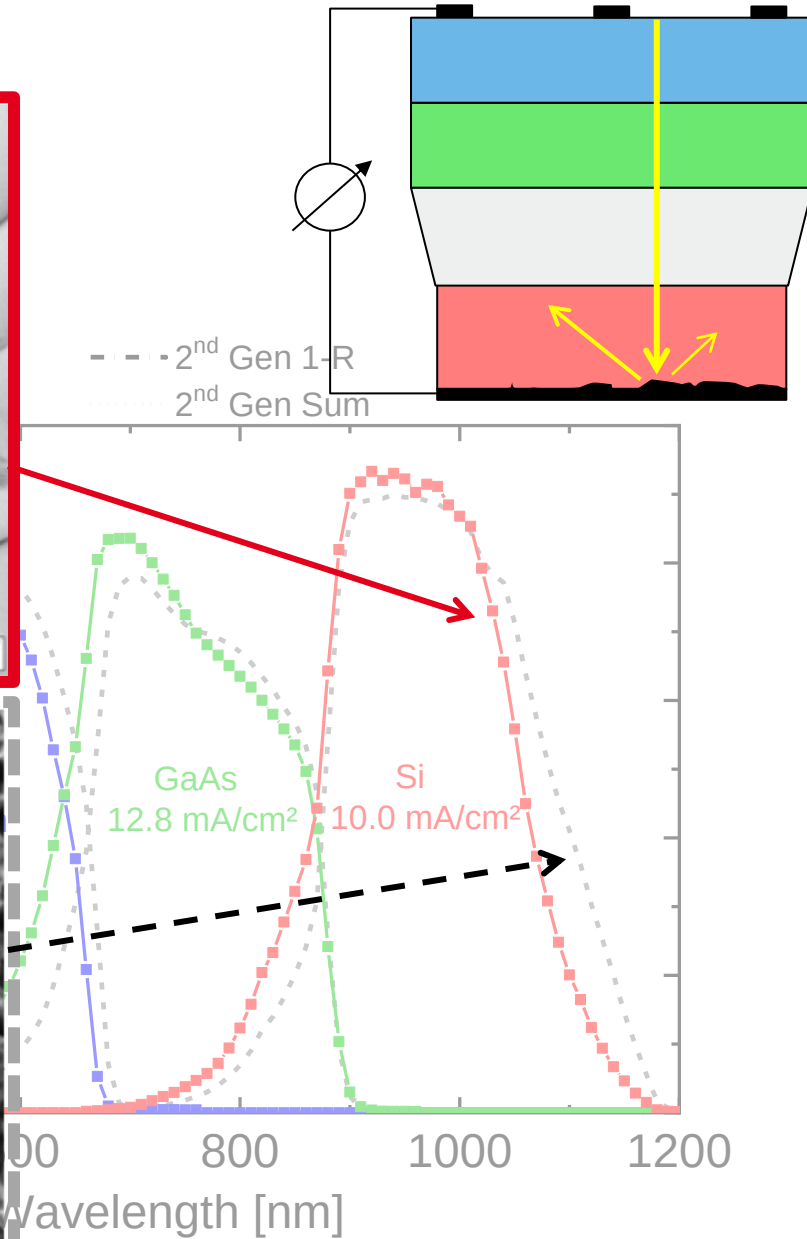
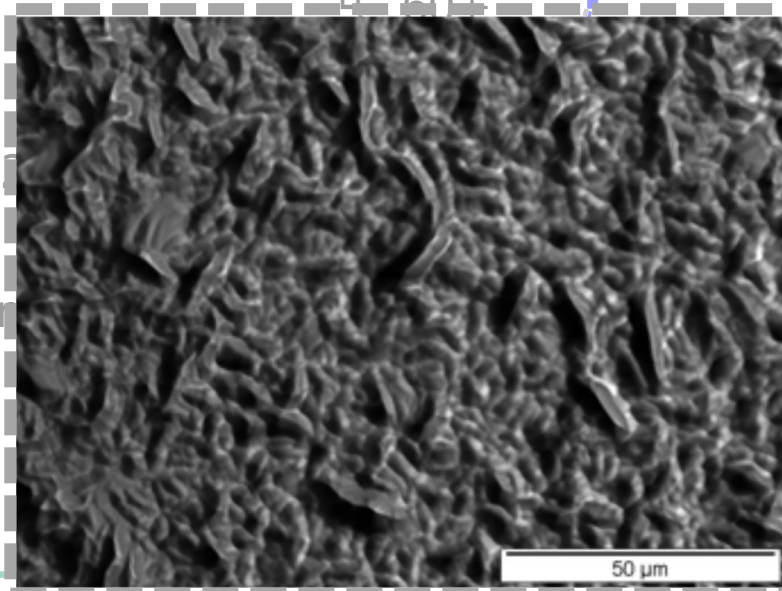
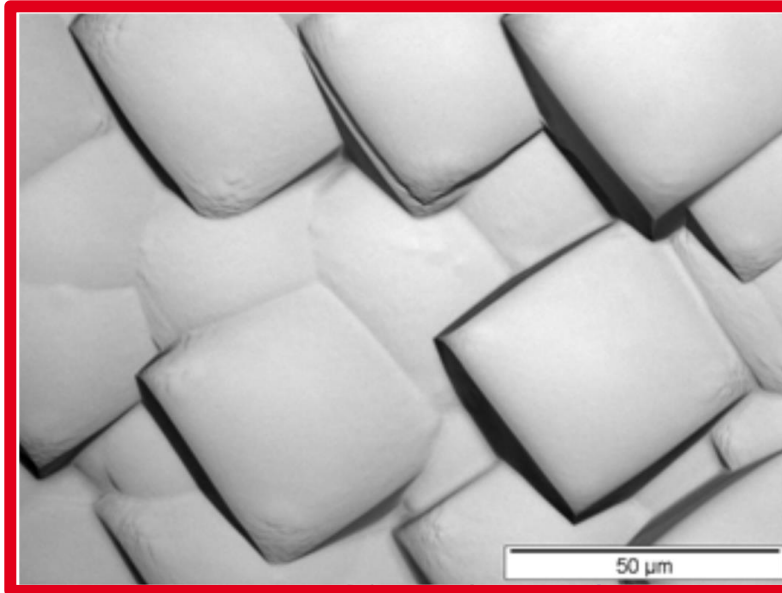
■ IV:

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■ EQE:

- GaInP bandgap adjusted
- Thinner GaAs cell (760 nm vs 1000 nm) with higher EQE
- Poor light trapping in Si bottom

Si back side texture



2nd Gen III-V on Si Solar Cell

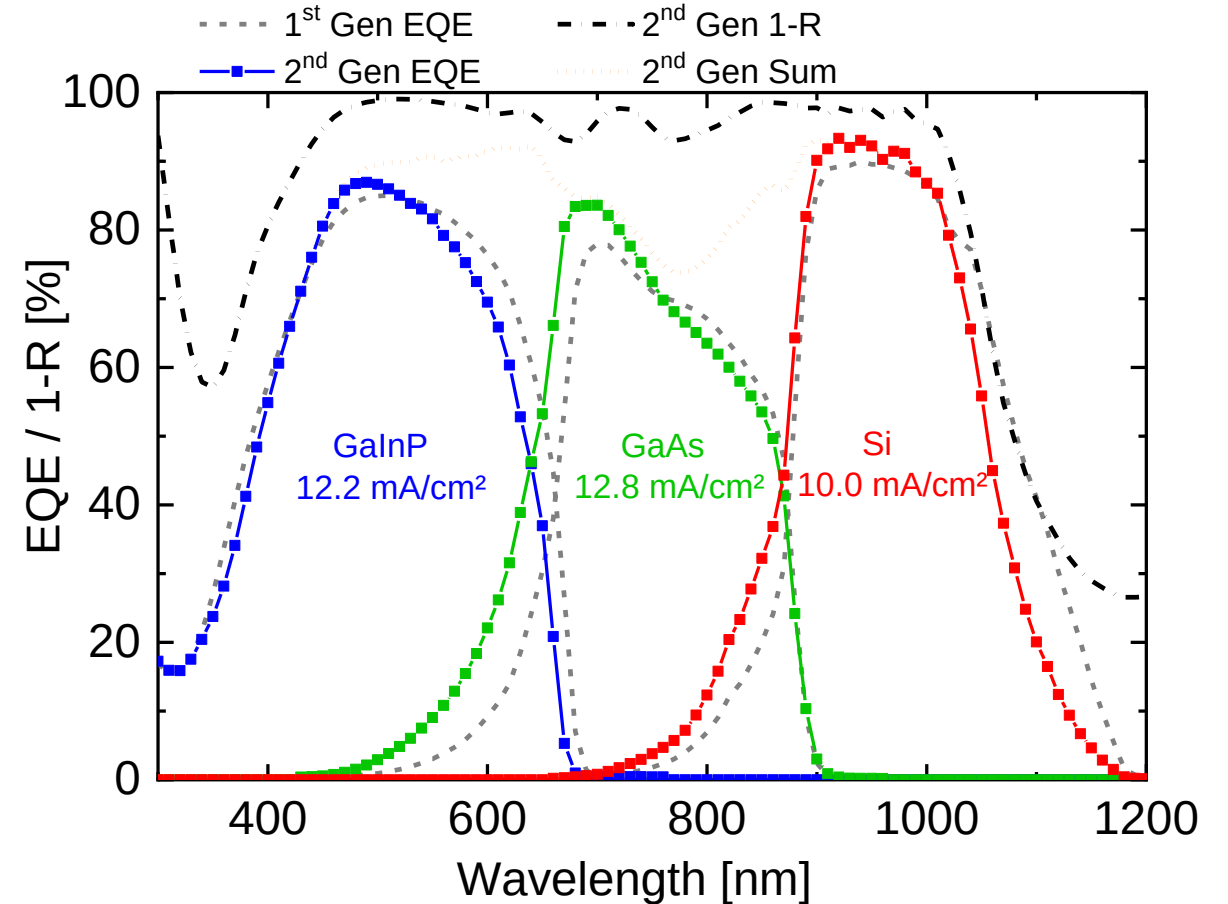
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■ IV:

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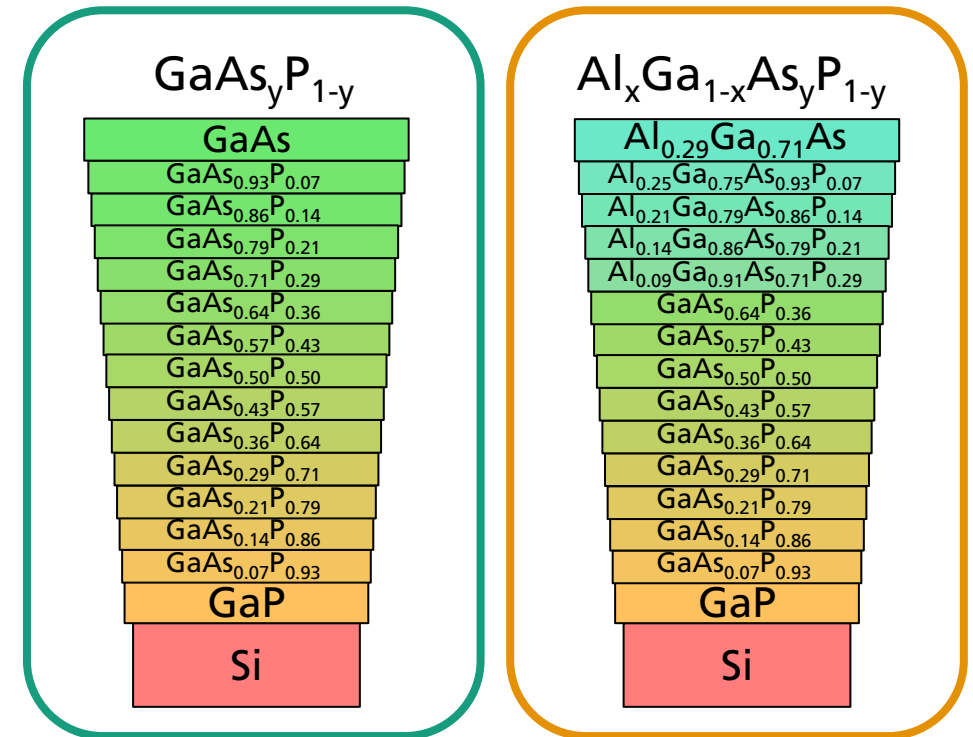
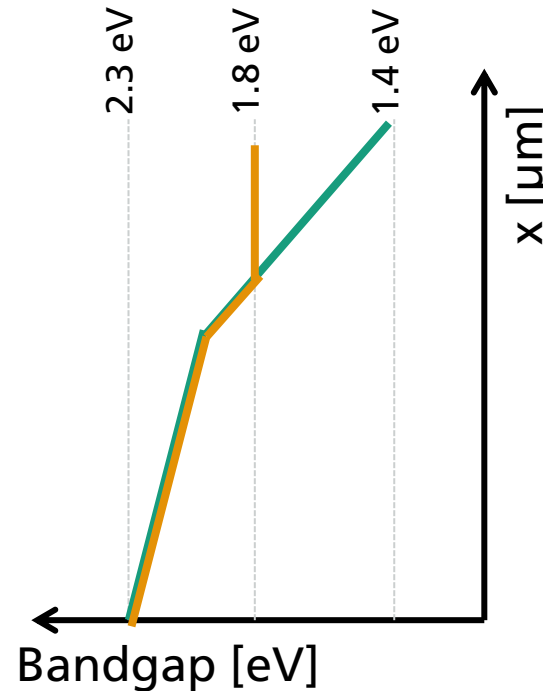
- GaInP bandgap adjusted
- Thinner GaAs cell (760 nm vs 1200 nm) with higher EQE
- Poor light trapping in Si bottom cell
- Strong parasitic absorption in GaAsP buffer for $700\text{nm} < \lambda < 900\text{ nm}$



2nd Gen III-V on Si Solar Cell

Parasitic Absorption

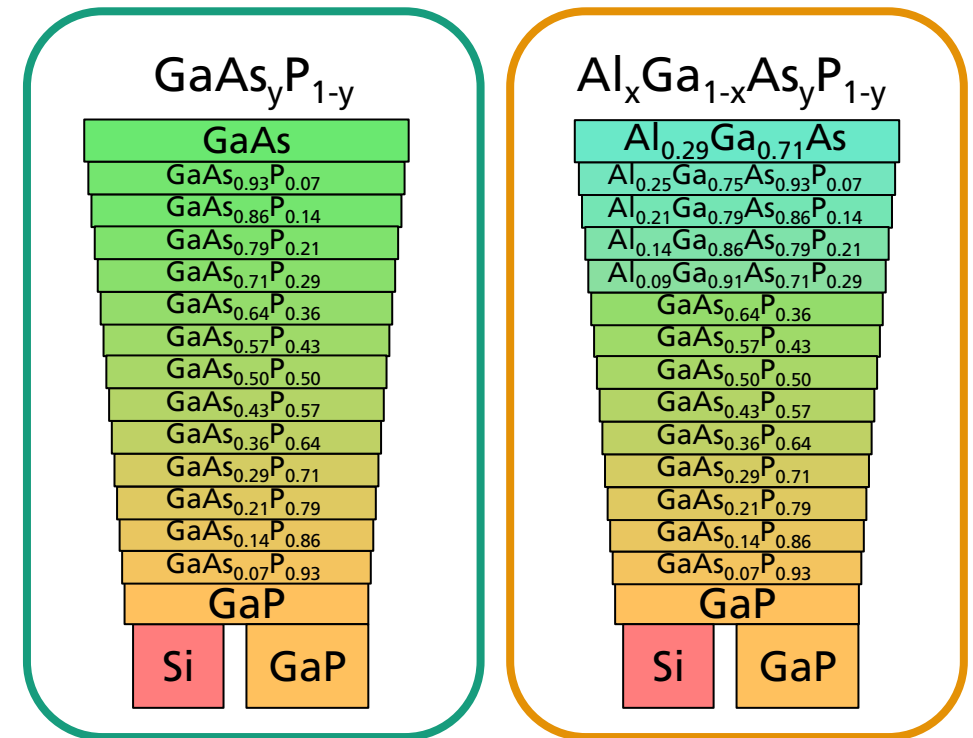
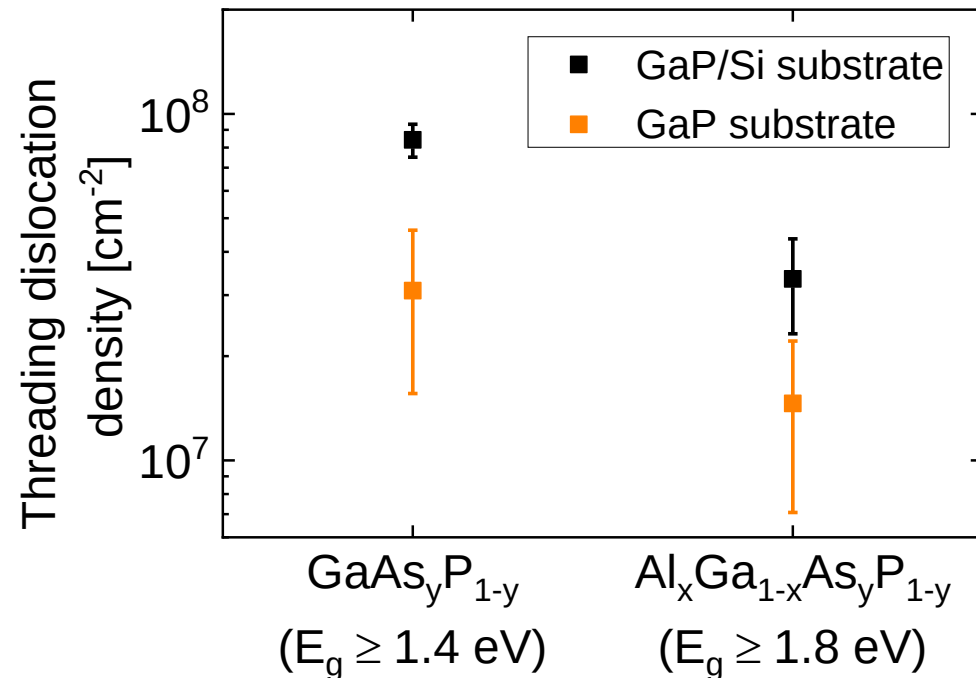
- Increase bandgap of buffer layers to $E_g \geq 1.8 \text{ eV} \equiv 690 \text{ nm}$
- $\text{Al}_{0.29}\text{Ga}_{0.71}\text{As}$ as last buffer layer



2nd Gen III-V on Si Solar Cell

Parasitic Absorption

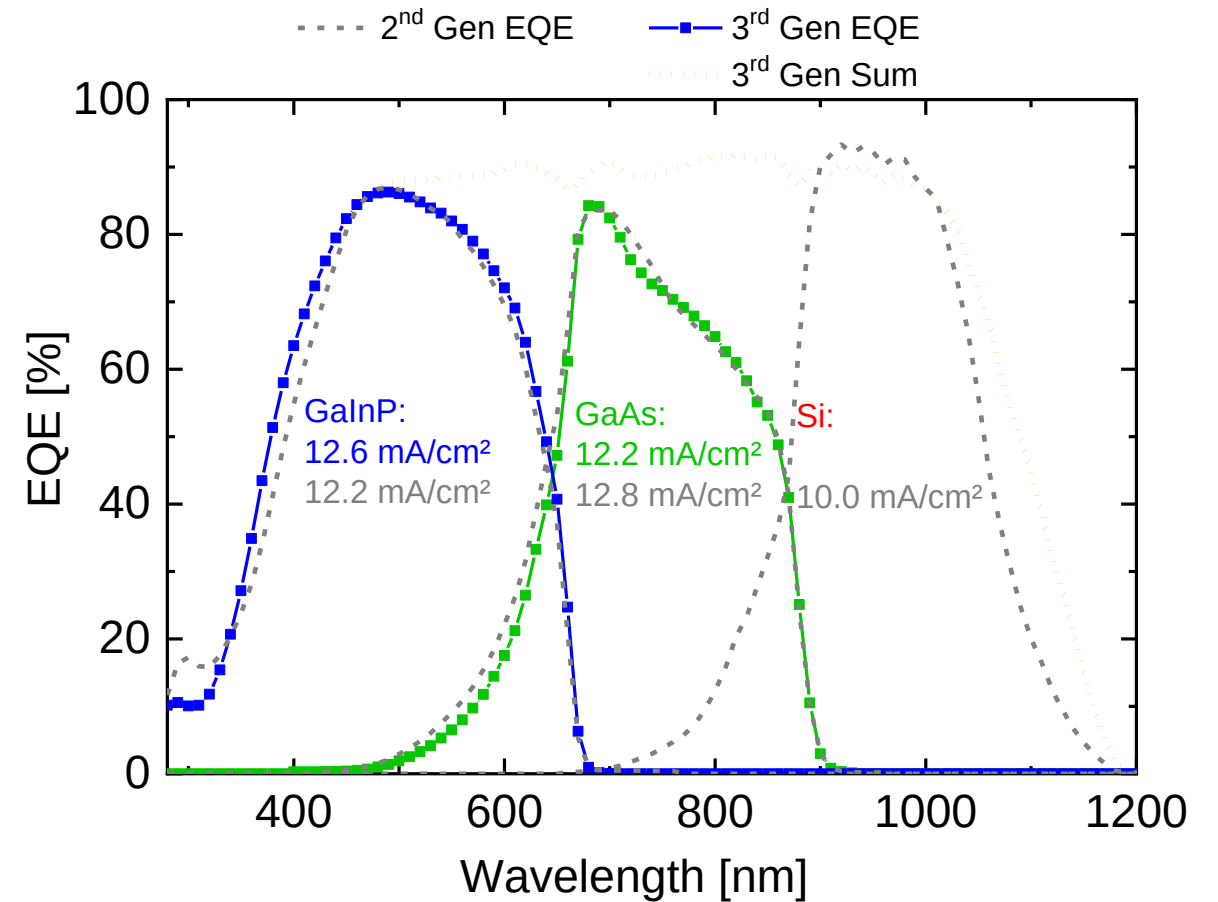
- Increase bandgap of buffer layers to $E_g \geq 1.8 \text{ eV} \equiv 690 \text{ nm}$
- $\text{Al}_{0.29}\text{Ga}_{0.71}\text{As}$ as last buffer layer
- Decreased threading dislocation density



3rd Gen III-V on Si Solar Cell (2019)

EQE

- EQE:
 - No significant change for GaInP and GaAs subcells

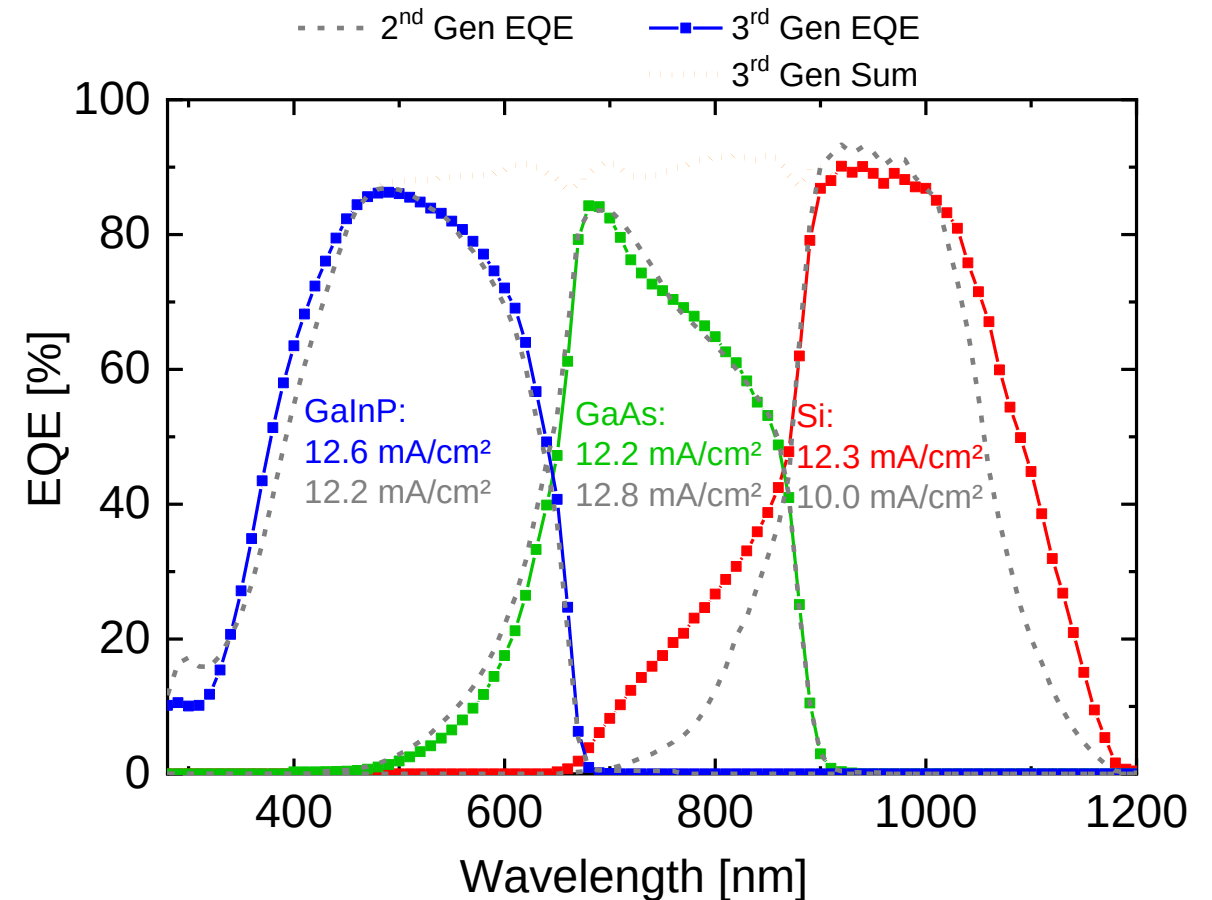


3rd Gen III-V on Si Solar Cell

EQE

■ EQE:

- No significant change for GaInP and GaAs subcells
- Improved/recovered light trapping
- No significant parasitic absorption
- +2.3 mA/cm² increase for Si subcell



3rd Gen III-V on Si Solar Cell

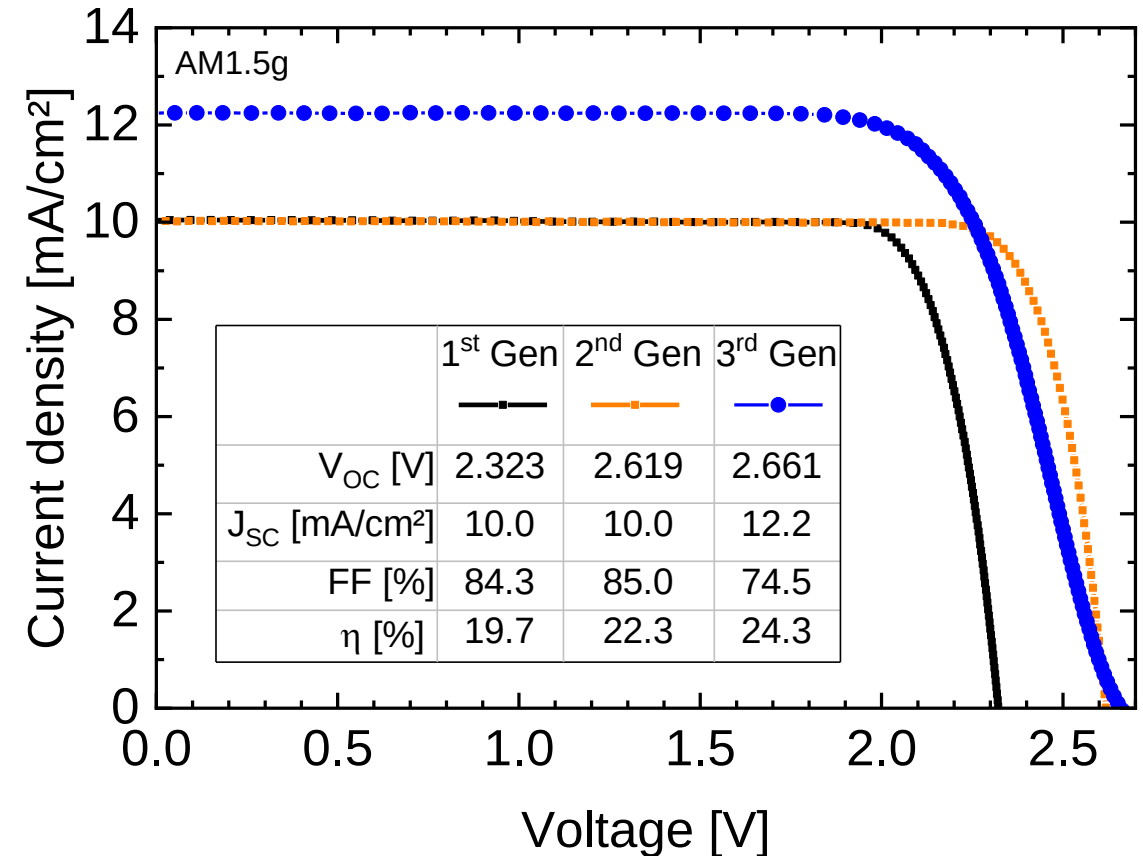
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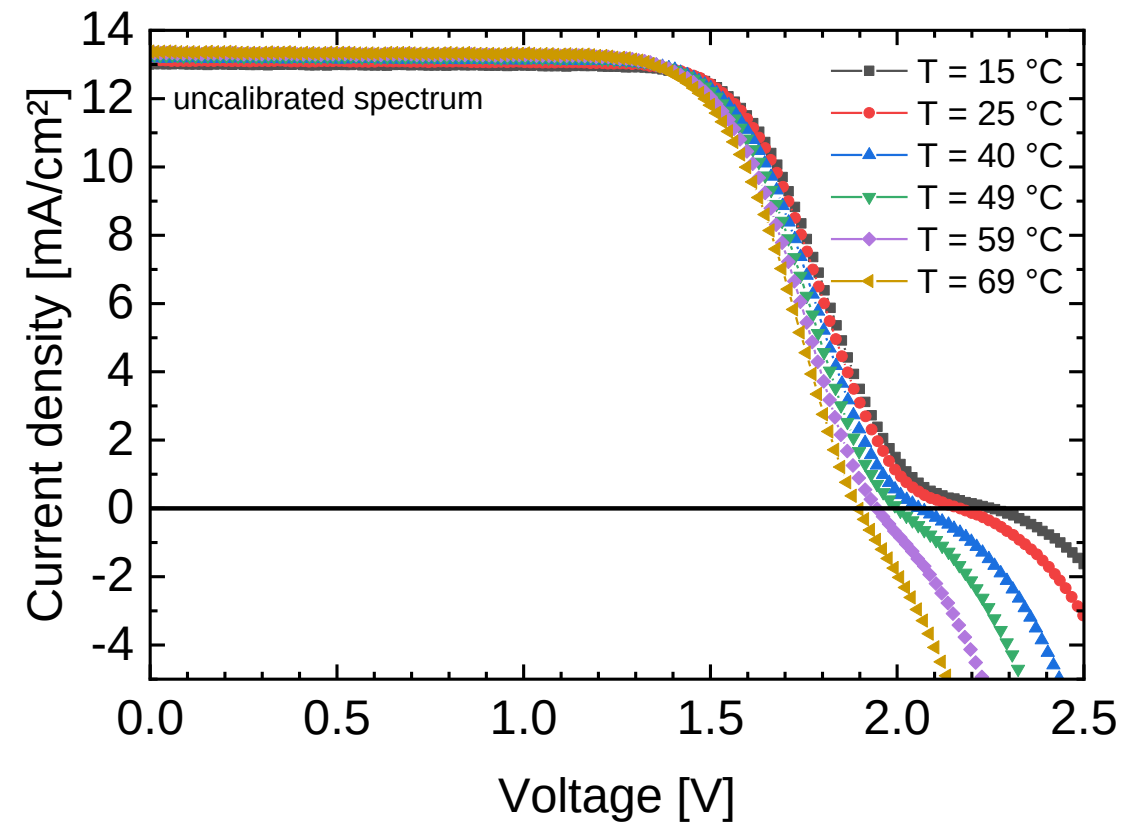
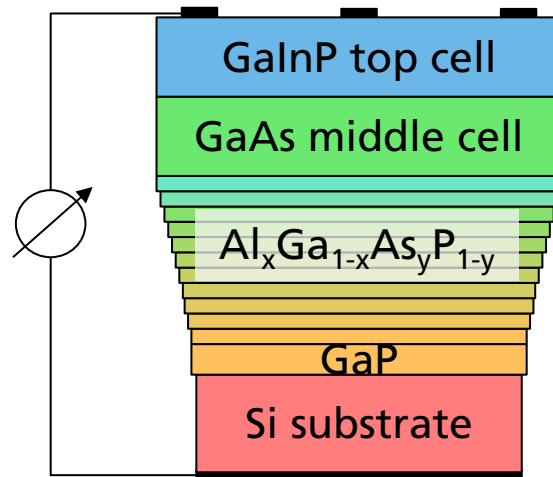
- Lower TDD leads to increased V_{OC}
- +2.2 mA/cm² gain in current
- 24.3 % efficiency under AM1.5g (4 cm²)
- Close to V_{OC} carrier transport issue occurs



3rd Gen III-V on Si Solar Cell

Temperature dependent IV

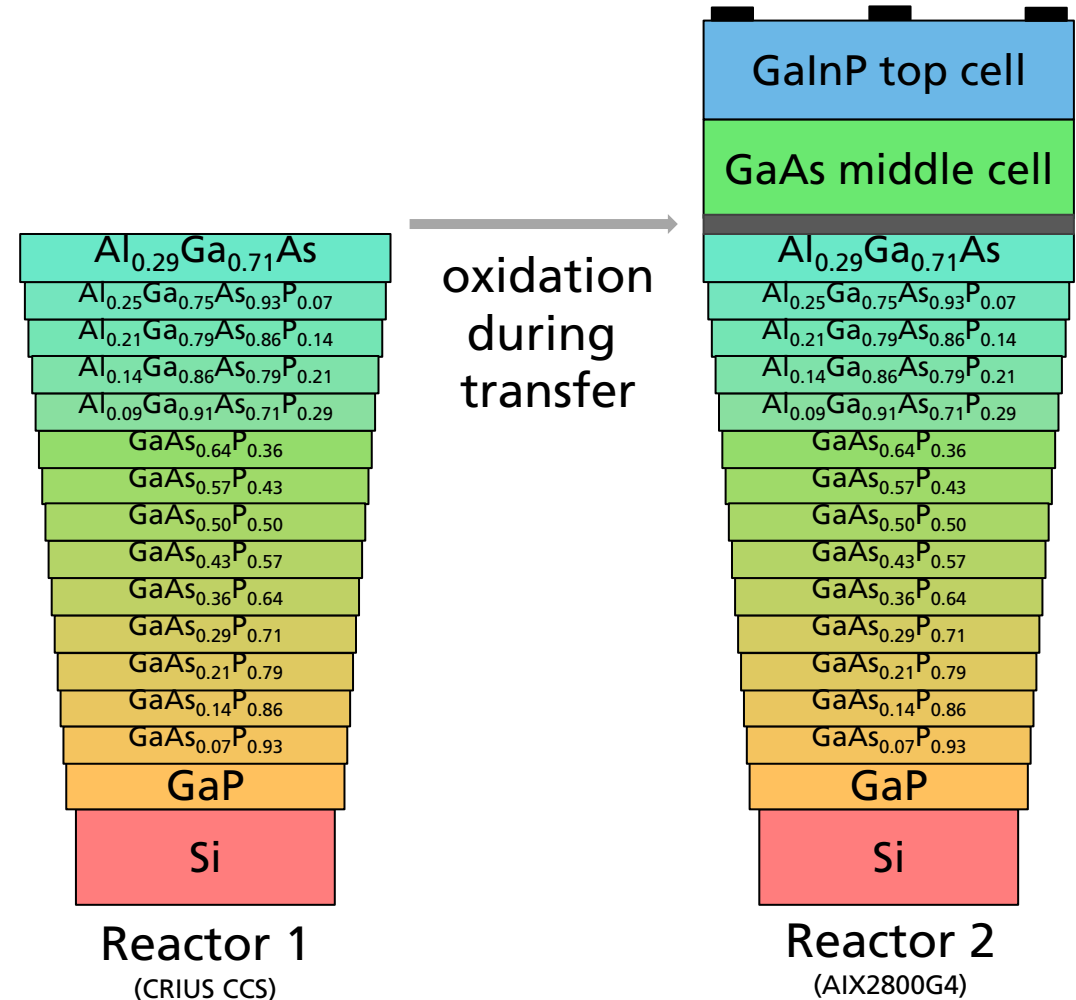
- S-shape in IV-characteristics
- Strong dependence on cell temperature
→ Majority barrier
- Barrier height¹⁾ 280 meV



3rd Gen III-V on Si Solar Cell

Temperature dependent IV

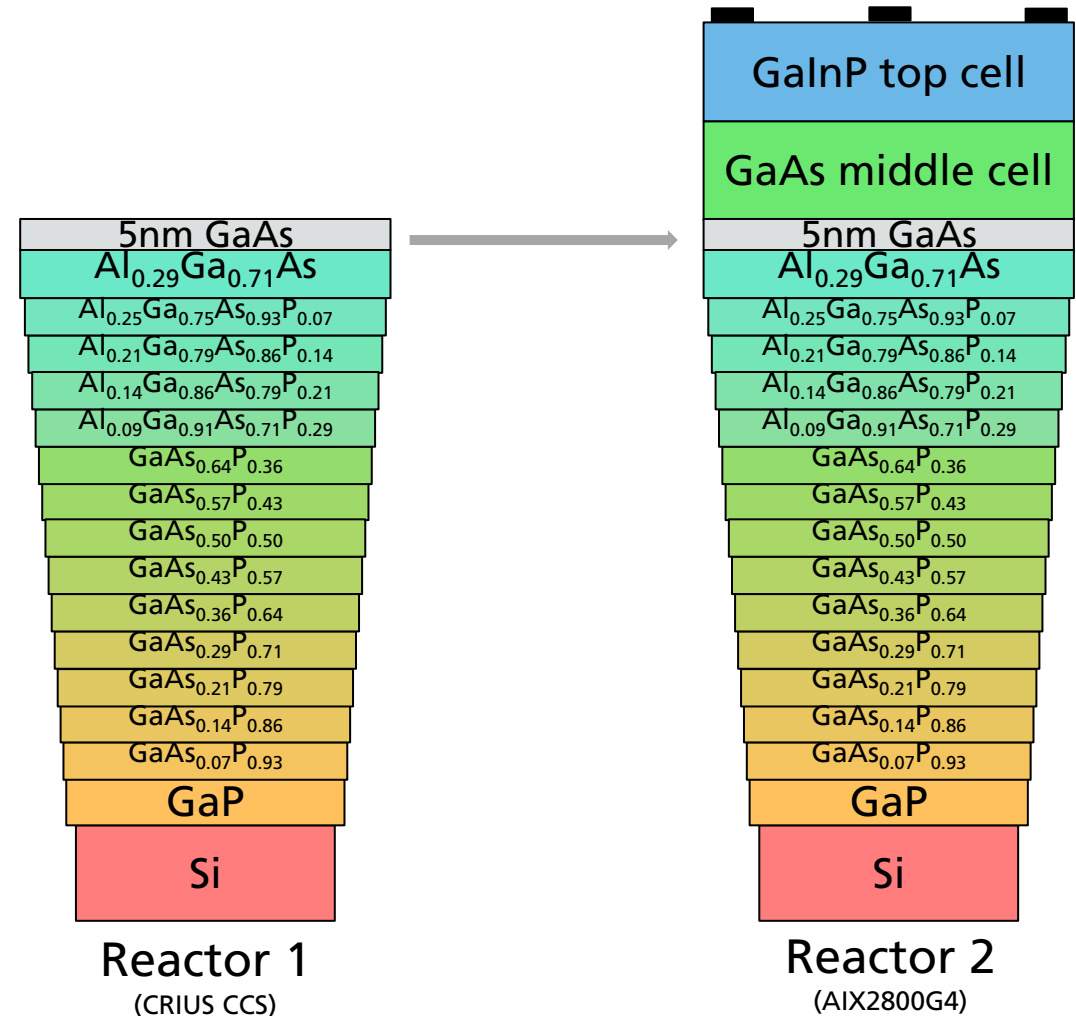
- S-shape in IV-characteristics
- Strong dependence on cell temperature
→ Majority barrier
- Barrier height¹⁾ 280 meV
- 2-step MOVPE process
 - Oxidation of $\text{Al}_{0.3}\text{Ga}_{0.7}\text{As}$ layer during transfer causes barrier



3rd Gen III-V on Si Solar Cell

Temperature dependent IV

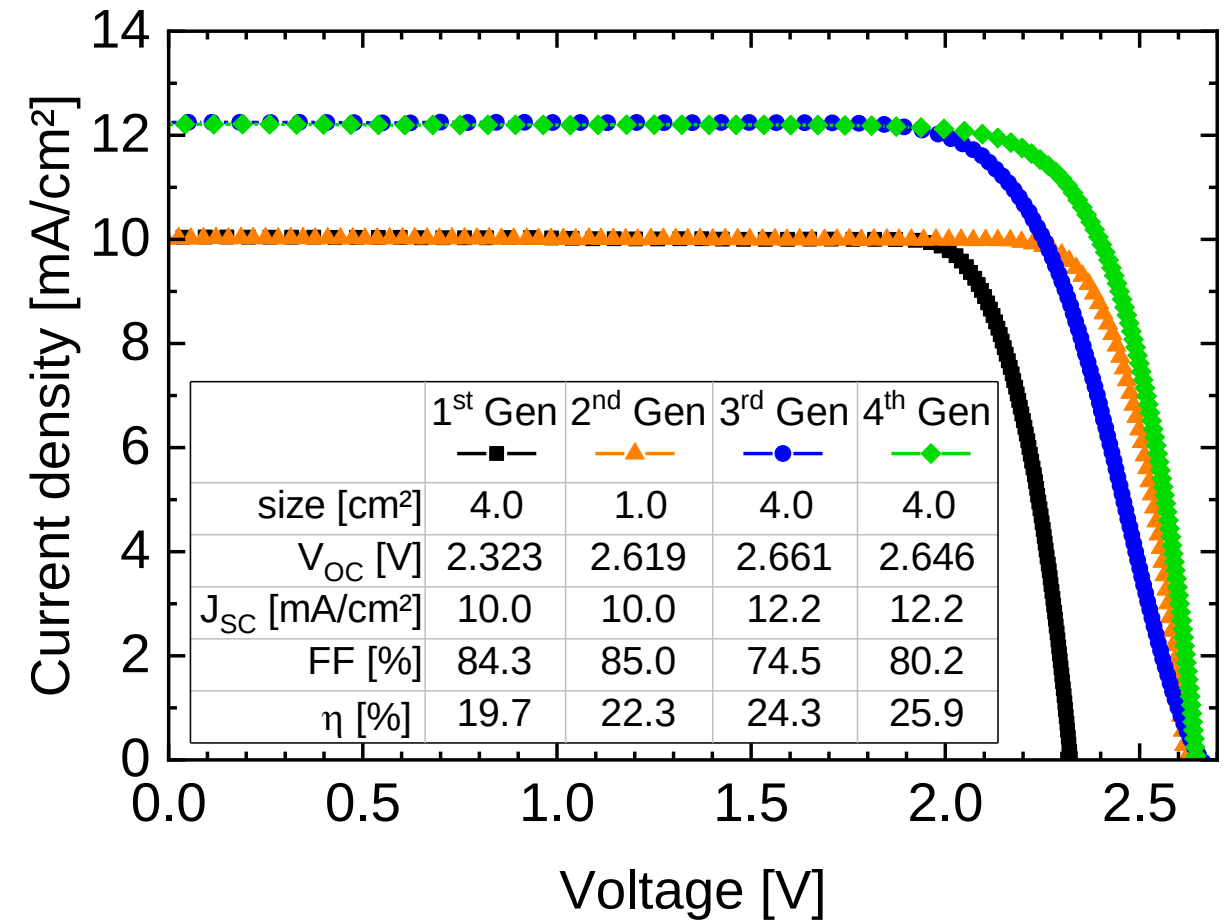
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→ Majority barrier
- Barrier height¹⁾ 280 meV
- 2-step MOVPE process
 - Oxidation of $\text{Al}_{0.3}\text{Ga}_{0.7}\text{As}$ layer during transfer causes barrier
 - 5 nm GaAs cap to suppress oxidation



4th Gen III-V on Si Solar Cell (2020)

IV-Characteristics

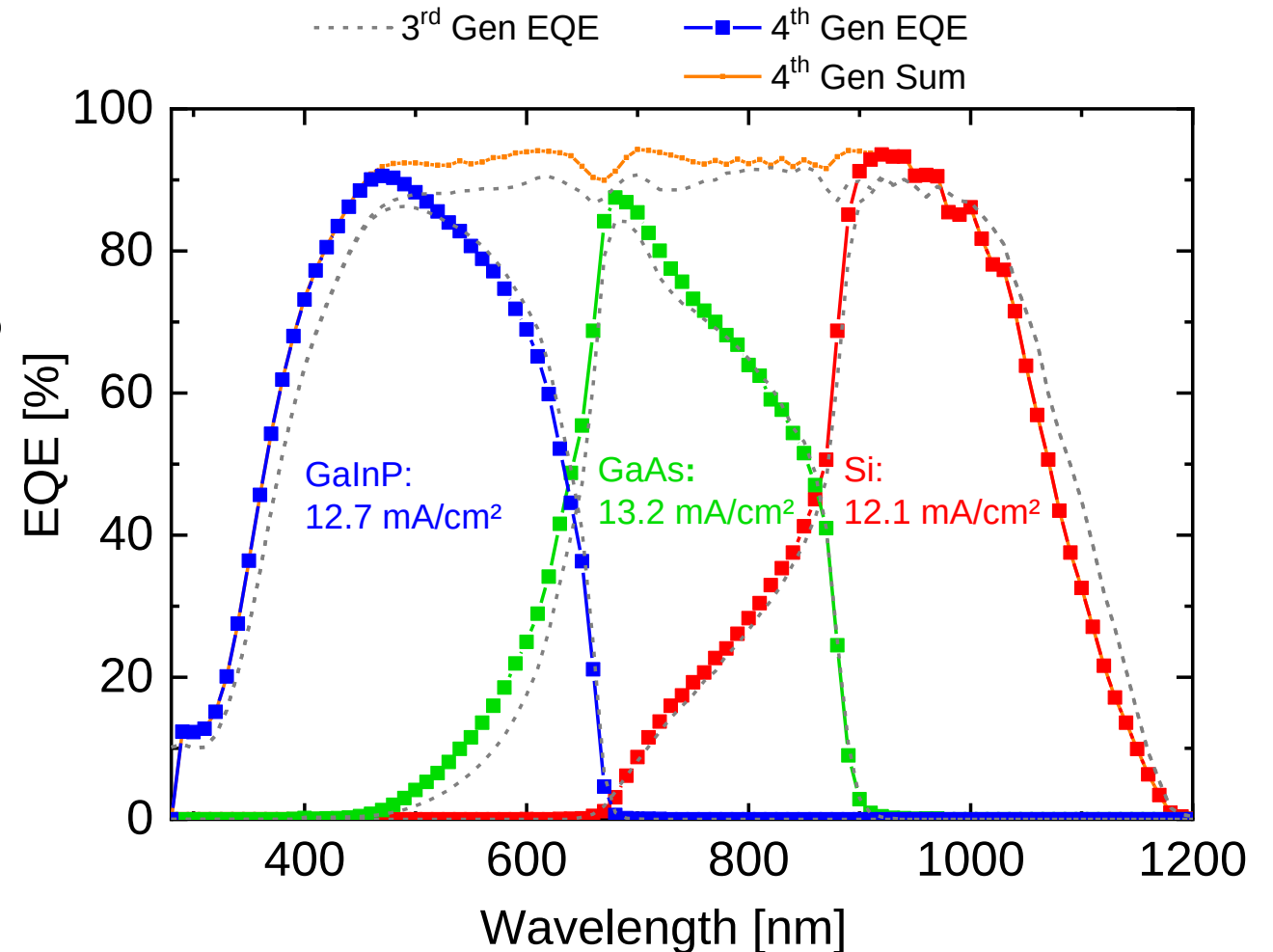
- IV:
- No sign of majority barrier
- Fill factor increased to 80.2 %
- Record efficiency: 25.9 % @ AM1.5g¹⁾



4th Gen III-V on Si Solar Cell

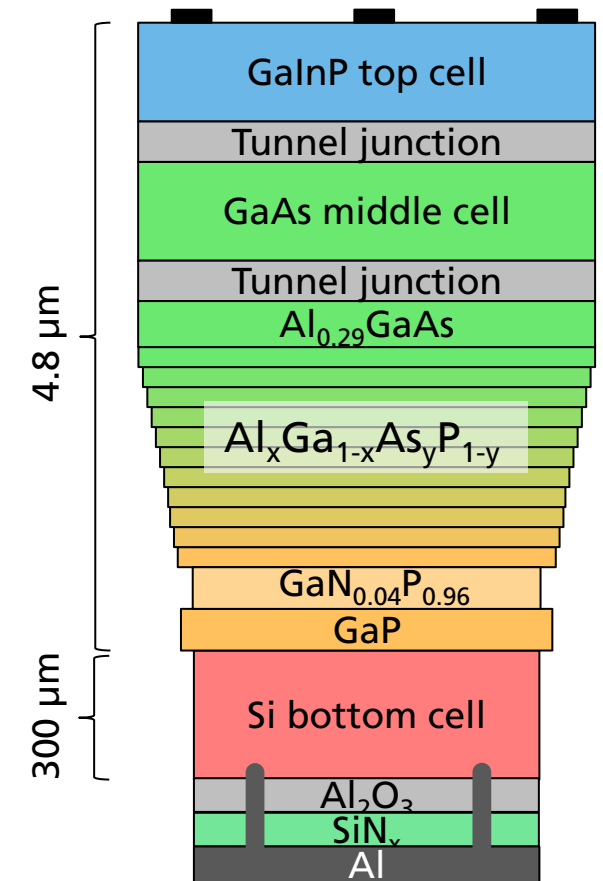
EQE

- IV:
 - No sign of majority barrier
 - Fill factor increased to 80.2 %
 - Record efficiency: 25.9 % @ AM1.5g¹⁾
- EQE:
 - Increased EQE for GaAs and GaInP cell (structural changes in cell structure)²⁾
 - Current matching to be adjusted in future device



Summary

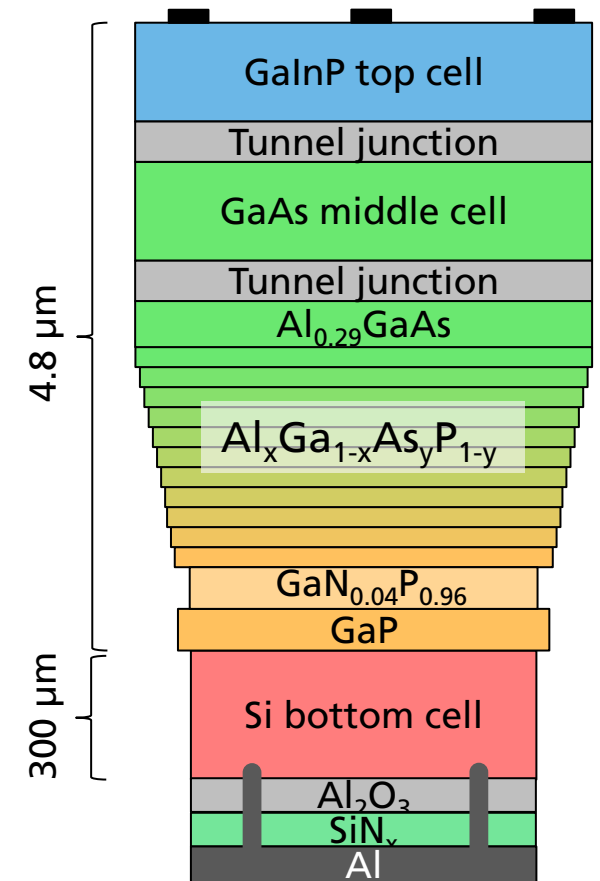
- MOVPE-growth of GaInP/GaAs/Si triple junction solar cells
- **Certified 25.9 % conversion efficiency @ AM1.5g for 4 cm² cell**
- Rapid efficiency improvement from 19.7 % (2017) to 25.9 % (2020)
 - Stacking fault (pyramid) density in GaP on Si nucleation layer reduced from $6 \times 10^7 \text{ cm}^{-2}$ to $< 10^5 \text{ cm}^{-2}$
 - Parasitic absorption in $\text{GaAs}_y\text{P}_{1-y}$ buffer structure suppressed by using $\text{Al}_x\text{Ga}_{1-x}\text{As}_y\text{P}_{1-y}$



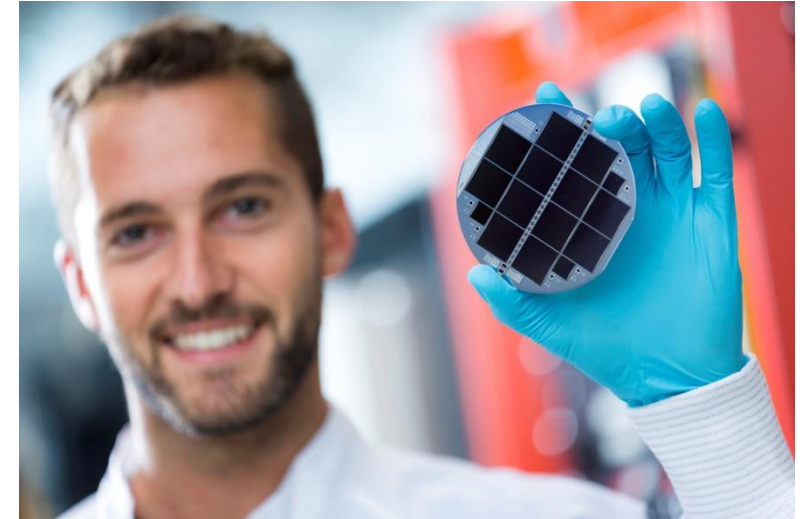
Summary

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 - Parasitic absorption in $\text{GaAs}_y\text{P}_{1-y}$ buffer structure suppressed by using $\text{Al}_x\text{Ga}_{1-x}\text{As}_y\text{P}_{1-y}$
- Outlook:
 - Record cell is grown on low-cost Si surface finish (no CMP)

TOPSiL



Thank you for listening!



Fraunhofer Institute for Solar Energy Systems ISE

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Acknowledgement

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Ref N: 03SF0525A

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